

Linear Driver for PIN Diode Attenuators

Rev. V5

Features

- Linearizes PIN Diode Attenuators Over a Wide Attenuation Range
- Output Currents up to 12 mA
- Operates with a Single Supply Voltage of +3V to +12V
- Low Quiescent Currents
- Single Control Voltage
- Test Boards are Available
- Tape and Reel Packaging Available
- SOW-16 Package

Description

M/A-COM's DR65-0002 is a break point free driver that produces a logarithmic output current suitable for linearizing PIN diode based shunt attenuators. This driver, in conjunction with customer defined external components, produces a linear transfer function (dB/V) between the input control voltage of the driver and the attenuation output of the PIN attenuator. The DR65-0002 has been optimized for linearizing M/A-COM's AT10-0009 or AT10-0017 attenuators, but will function well with most types of cathode grounded, PIN attenuators. The driver is packaged in a SOW-16 package for commercial SMT applications. A typical schematic for a 30 dB, 7.5 dB/V linear attenuator is shown in Figure 1.

Circuit Description:

(Reference Figures 1 and 2)

The input divider, R1 and the sum of R2 and R3, sets the overall transfer function of the circuit. To increase the transfer function, decrease the Control Voltage and the value of R1. Varying the value of R4 will optimize the linearity of the circuit. One can achieve a very linear transfer function (less than ± 1 dB/V) by driving the attenuator over a smaller portion of its dynamic range. In the case of the AT10-0009 and AT10-0017 attenuators, this would be limited to a dynamic range of 28 and 25 dB, respectively. Temperature compensation is a function temperature coefficient of the thermistor, R3, and the ratio of R2 to R3, and can only be optimized once the transfer function and linearity component values have been established.

Ordering Information

Part Number	Package
DR65-0002	Bulk Packaging
DR65-0002TR	1000 piece reel
DR65-0002-TBG	Test Board with Circuit per Figure 1 (AT10-0009, GSM Attenuator)
DR65-0002-TBP	Test Board with Circuit per Figure 1 (AT10-0017, PCS Attenuator)

Note: Reference Application Note M513 for reel size information.

Pin Configuration

Pin No.	Function	Pin No.	Function
1	N/C	9	N/C
2	N/C	10	N/C
3	REF	11	N/C
4	INPUT +	12	OUTPUT
5	GND	13	N/C
6	N/C	14	+ V _{CC}
7	N/C	15	N/C
8	N/C	16	N/C

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Figure 1. Linear Attenuator Schematic

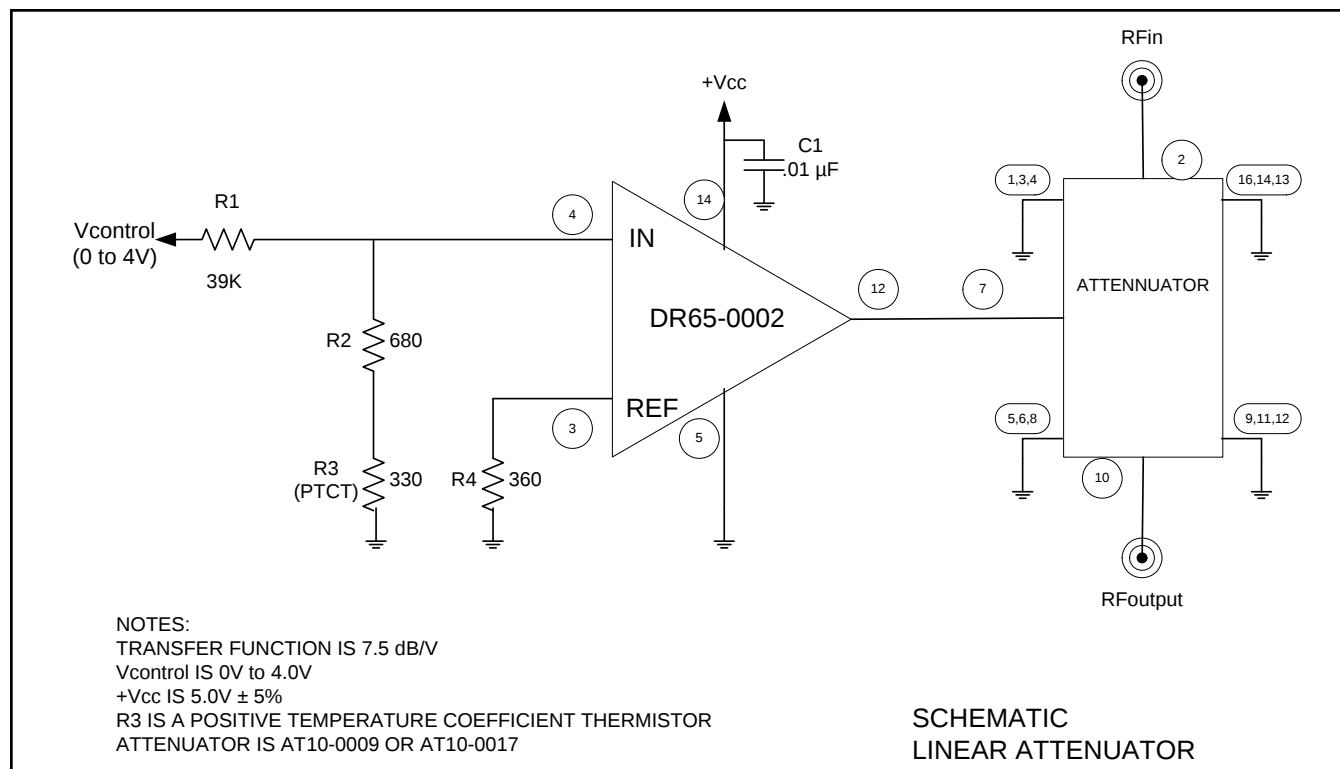
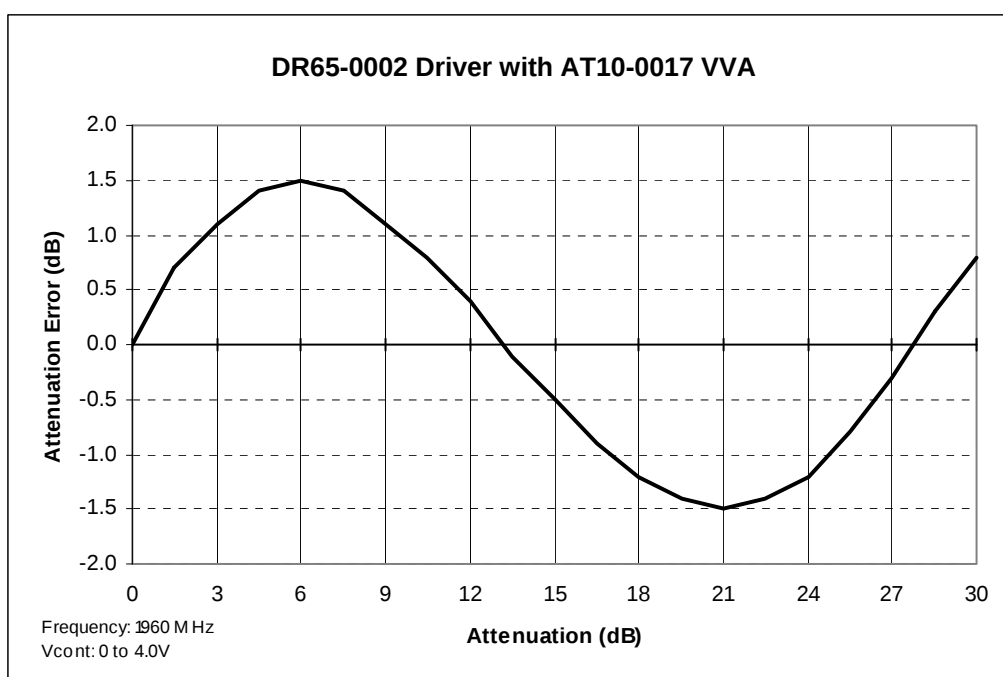


Figure 2. Typical Attenuation Error



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Electrical Specifications: $T_A = 25^\circ\text{C}$, $Z_0 = 50\Omega$

Parameter	Test Conditions	Units	Min	Typ	Max
Output Drive Current	Load Dependent	mA	10	—	—
+V _{CC} Supply Range	—	V	3.0	5.0	12
+V _{CC} Supply Tolerance	—	%	—	5	—
+V _{CC} Quiescent Current	No Load	mA	—	1.0	2.0
Linearity	Application Dependent	dB	± 1	± 2.5	—
Transfer Function	Application Dependent	dB/V	3	7.5	10
Settling Time	50% Ctl to 90%/10% RF	μs	—	50	—

Absolute Maximum Ratings^{1,2}

Parameter	Absolute Maximum
+V _{CC}	+20 V
Input +	± 5 V
REF	± 5 V
Output Current	20 mA
Operating Temperature	-40°C to +85°C
Storage Temperature	-65°C to +125°C
Package Power Dissipation	150 mW
Lead Temperature	300°C for 10 seconds

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM does not recommend sustained operation near these survivability limits.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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Technical drawing of a 16-pin DIP package showing top, side, and detail views with dimensions in inches and millimeters.

Top View:

- Pin 16 at top, Pin 1 at bottom.
- Dimensions: .4055 (10.30) total width, .2952 (7.50) pin pitch, .4053 (10.30) body width.
- Labels: COMPANY LOGO, PART NUMBER (XXXXXXXXXX), DATE/LOT CODE (YYWWXXXX), ORIENTATION MARK.

Side View:

- Dimensions: .0550 (1.40) total height, .0500 (1.27) body height, .0157 (0.40) lead height.
- Lead angle: 45°.

Detail View (Pin):

- Dimensions: .0807 (2.05) MIN. lead length, .1043 (2.65) MAX. lead length, .0500 (1.27) pin diameter, .0200 (0.51) / .0122 (0.31) pin thickness, .0118 (0.30) / .0039 (0.10) pin width.
- Label: SEATING PLANE.

Section B-B:

- Dimensions: .0201 (0.51) / .0122 (0.31) base material thickness, .0130 (0.33) / .0079 (0.20) with plating thickness, .0189 (0.48) / .0106 (0.27) total thickness.
- Labels: BASE MATERIAL, WITH PLATING.

NOTES:

1. REFERENCE JEDEC MS-013-AA, FOR ADDITIONAL DIMENSIONAL AND TOLERANCE INFORMATION.
2. REFERENCE M538 APPLICATION NOTE FOR FOOTPRINT INFORMATION.
3. ALL DIMENSIONS SHOWN AS INCHES/MM.

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